

November 2, 2017

## Encision to Present at the 10th Annual LD Micro Main Event Conference

Boulder, Colorado, November 2, 2017 -- Encision Inc. (ECIA), a medical device company owning patented surgical technology that prevents dangerous stray electrosurgical burns in minimally invasive surgery, today announced that management will participate in the 10th Annual LD Micro Main Event Conference. The conference will be held at the Luxe Sunset Boulevard Hotel, located in Los Angeles, California. Attendance at the conference is by invitation only.

Greg Trudel, President and CEO of Encision, will host a presentation with investors on Tuesday, December 5 at 8:30 AM Pacific Time and management will participate in private one-on-one meetings during the days of December 5 and 6.

Encision Inc. designs and markets a portfolio of high performance surgical instrumentation that delivers advances in patient safety with AEM technology, surgical performance, and value to hospitals across a broad range of minimally invasive surgical procedures. Based in Boulder, Colorado, the company pioneered the development and deployment of Active Electrode Monitoring, AEM technology, to eliminate dangerous stray energy burns during minimally invasive procedures. For additional information about all our products, please visit www.encision.com.

CONTACT: Mala Ray, Encision Inc., 303-444-2600, mray@encision.com